

INTERNATIONAL
GEMOLOGICAL
INSTITUTE

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LABORATORY GROWN DIAMOND REPORT

November 21, 2025

IGI Report Number

LG747512587

Description

LABORATORY GROWN DIAMOND

Shape and Cutting Style

ROUND BRILLIANT

Measurements

6.48 - 6.53 X 3.94 MM

GRADING RESULTS

Carat Weight

1.01 CARAT

Color Grade

D

Clarity Grade

VVS 1

Cut Grade

IDEAL

ADDITIONAL GRADING INFORMATION

Polish

EXCELLENT


Symmetry

EXCELLENT

Fluorescence

NONE

Inscription(s)

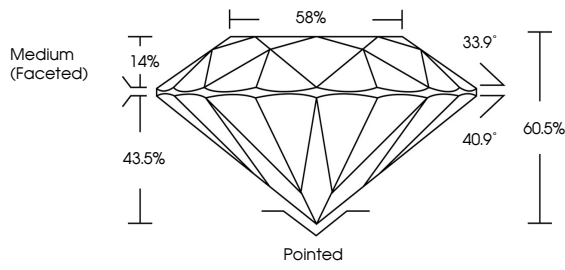
 LG747512587

Comments: As Grown - No indication of post-growth treatment.
This Laboratory Grown Diamond was created by High Pressure High Temperature (HPHT) growth process.
Type II

LG747512587

Report verification at igi.org

PROPORTIONS



Medium (Faceted)

58%

33.9°

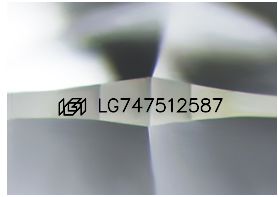
40.9°

60.5%

43.5%

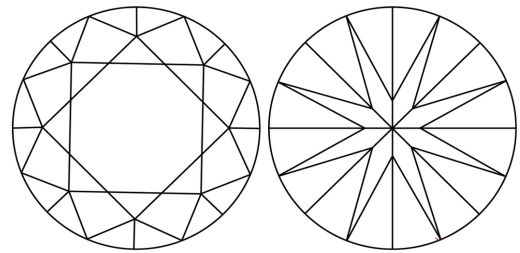
14%

Pointed



Sample Image Used

CLARITY CHARACTERISTICS



KEY TO SYMBOLS

Red symbols indicate internal characteristics.
Green symbols indicate external characteristics.

COLOR


D E F G H I J Faint Very Light Light

CLARITY

FL IF VVS¹⁻² VS¹⁻² SI¹⁻² I¹⁻³

Flawless Internally Flawless Very Very Slightly Included Very Slightly Included Slightly Included Included

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IGI

November 21, 2025

IGI Report No LG747512587

ROUND BRILLIANT

6.48 - 6.53 X 3.94 MM

Carat Weight

1.01 CARAT

Color Grade

D

Clarity Grade

VVS 1

Cut Grade

IDEAL

Depth

60.5%

Table

88%

Girdle

Medium (Faceted)

Culet

Pointed

Polish

EXCELLENT


Symmetry

EXCELLENT

Fluorescence

NONE


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